PRODUCT SPECIFICATION FOR LCD MODULE

Revision: 1.0

Model No: LSC055I19-MP-V1

Module Type: COG+FPC+B/L+CTP

APPROVED SIGNATURE

■ Approved Product Specification only

□ Approved Product Specification and Samples

Prepared By	Checked By	Approved By

Contents

目录

1. General Description

LSC055I19-MP-V1 is a transmissive type a-Si TFT-LCD (amorphous silicon thin film transistor liquid crystal display) module, which is composed of a TFT-LCD panel, a driver circuit and a backlight unit. The panel size is 5.5 inch and the resolution is 720(RGB)*1280, the panel can display up to 16.7M colors.

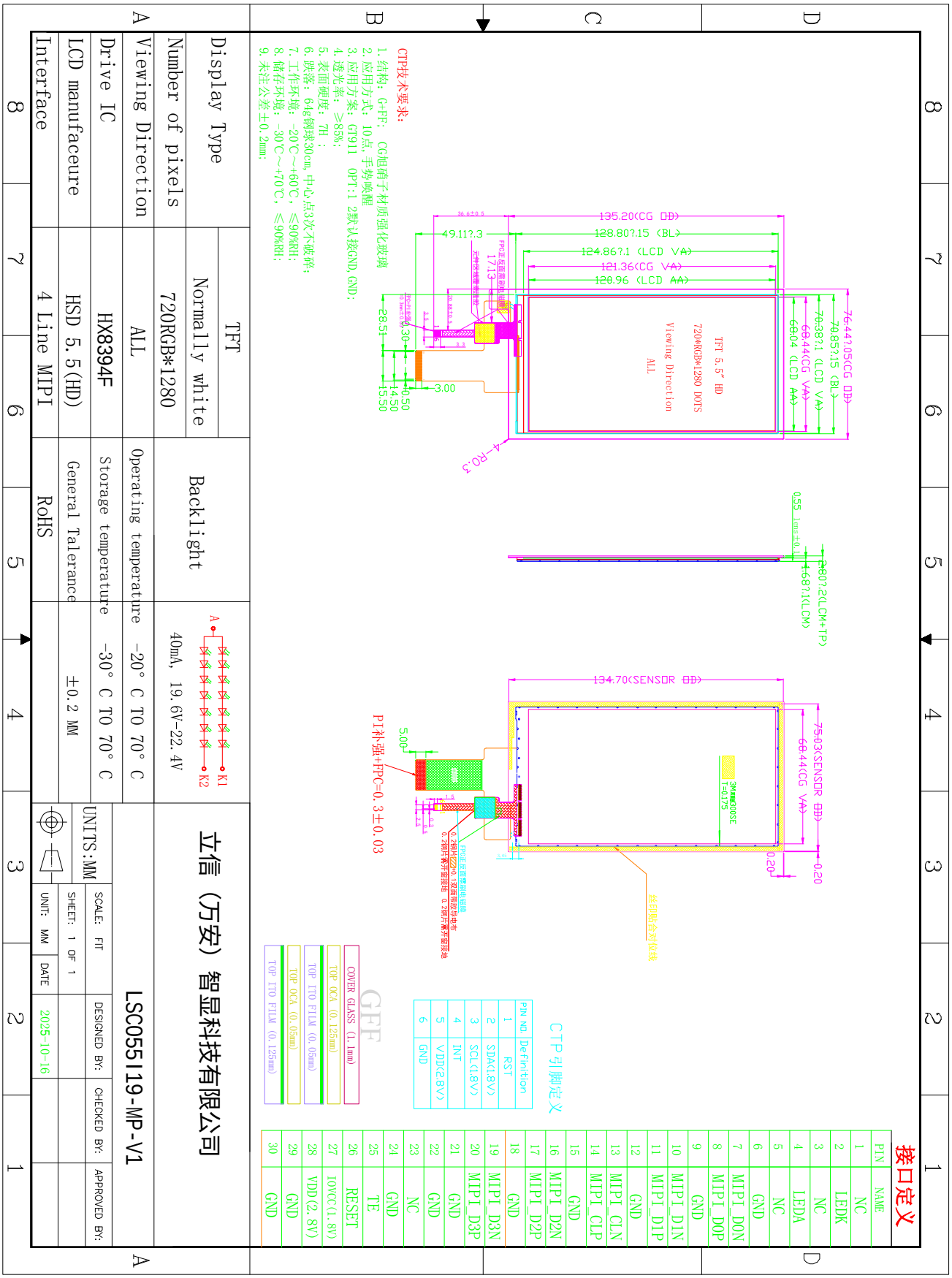
2. Physical Features

Display Mode	TFT-LCD Module
	Active matrix TFT, Transmissive type
Display Format	Graphic 720(RGB)×1280 Dot-matrix
Input Data	MIPI
Viewing Direction （Grayscale Inversion）	Free（IPS）
Drive	ILI9881C

3. Mechanical Specification

Item	Specification	Unit
Module size (H×V×D)	76.44 ×135.2×2.8	mm
Number of dots	720(RGB) ×1280	pixel
Active area (H×V)	68.04×120.96	mm

4. Outline Dimension



5. Absolute Maximum Ratings

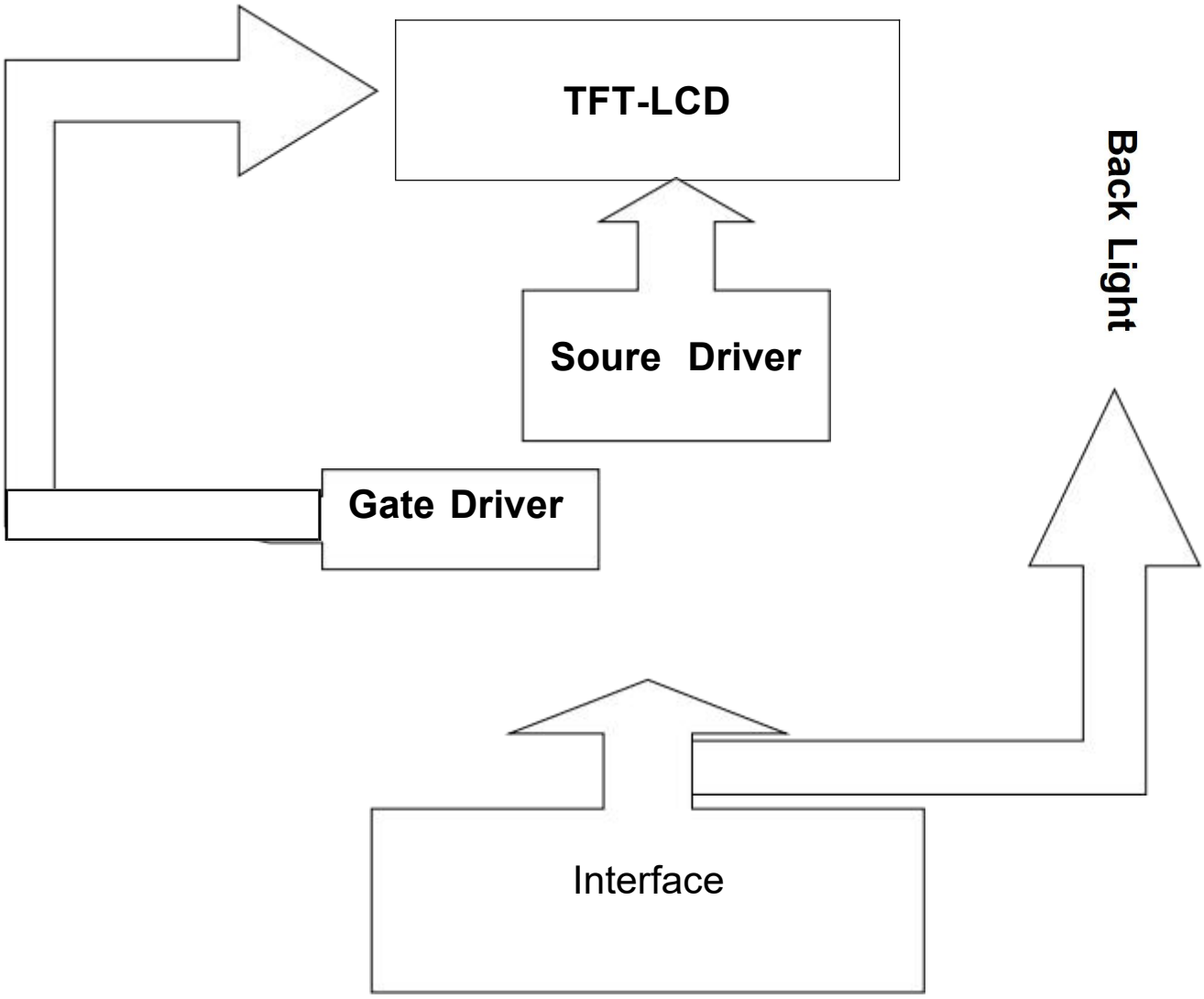
Item	Symbol	Min	Max	Unit	Remark
Supply voltage	VCC	-0.3	6	V	Note1 Note2
Supply voltage	IOVCC	-0.3	3.8	V	
Operating temperature	TOPR	-20	70	℃	
Storage temperature	TSTR	-30	70	℃	

6. Electrical Characteristics

Item		Symbol	Rating			Unit	Remark
			Min	Typ	Max		
Supply voltage		VCC	2.4	2.8	3.3	V	Note1
Supply voltage		IOVCC	1.65	1.8	3.3	V	
Input Voltage	L level	VIL	0	---	0.3*IOVCC	V	
	H level	VIH	0.7*IOVCC	---	IOVCC	V	

7. Module Function Description

7-1. Block Diagram Of LCM



7-2. Pin Description

FPC connector is used for electronics interface

PinNo.	Symbol	Function
1	NC	NC
2	LEDK	LED back light(Cathode)
3	NC	NC
4	LEDA	LED back light(Anode)
5	NC	NC
6	GND	Ground
7	MIPI_D0N	MIPI DSI differential data
8	MIPI_D0P	MIPI DSI differential data
9	GND	Ground
10	MIPI_D1N	MIPI DSI differential data
11	MIPI_D1P	MIPI DSI differential data
12	GND	Ground
13	MIPI_CLN	MIPI DSI differential clock
14	MIPI_CLP	MIPI DSI differential clock
15	GND	Ground
16	MIPI_D2N	MIPI DSI differential data
17	MIPI_D2P	MIPI DSI differential data
18	GND	Ground
19	MIPI_D3N	MIPI DSI differential data
20	MIPI_D3P	MIPI DSI differential data
21-22	GND	Ground
23	NC	NC
24	GND	Ground
25	TE	Frame synchronization signal
26	RESET	external reset input
27	IOVCC(1.8V)	Power Supply 1.8V
28	VDD(2.8V)	Power Supply 2.8V
29-30	GND	Ground

CTP connector is used for electronics interface

1	RST	Touch screen reset
2	SDA	Touch screen data signal
3	SCL	Touch screen clock signal
4	INT	Touch screen interrupt signal
5	VDD	Power Supply
6	GND	Ground

7-3 Timing Characteristics

17.4.2. High Speed Mode – Clock Channel Timing

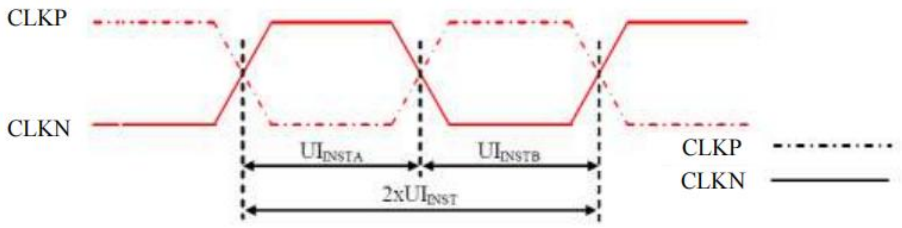


Figure 105: DSI Clock Channel Timing

Table 38: DSI Clock Channel Timing

Signal	Symbol	Parameter	Min	Max	Unit
CLKP/N	$2xUI_{INST}$	Double UI instantaneous	*Note 2*	25	ns
CLKP/N	UI_{INSTA}, UI_{INSTB} (Note 1)	UI instantaneous Half	*Note 2*	12.5	ns

Notes:

1. UI = UIINSTA = UIINSTB

2. Define the minimum value, see Table 39.

Table 39: Limited Clock Channel Speed

Data type	Two Lanes speed	Three Lanes speed	Four Lanes speed
Data Type = 00 1110 (0Eh), RGB 565, 16 UI per Pixel	566 Mbps	466 Mbps	366 Mbps
Data Type = 01 1110 (1Eh), RGB 666, 18 UI per Pixel	637 Mbps	525 Mbps	412 Mbps
Data Type = 10 1110 (2Eh), RGB 666 Loosely, 24 UI per Pixel	850 Mbps	750 Mbps	650 Mbps
Data Type = 11 1110 (3Eh), RGB 888, 24 UI per Pixel	850 Mbps	750 Mbps	650 Mbps

17.4.3. High Speed Mode – Data Clock Channel Timing

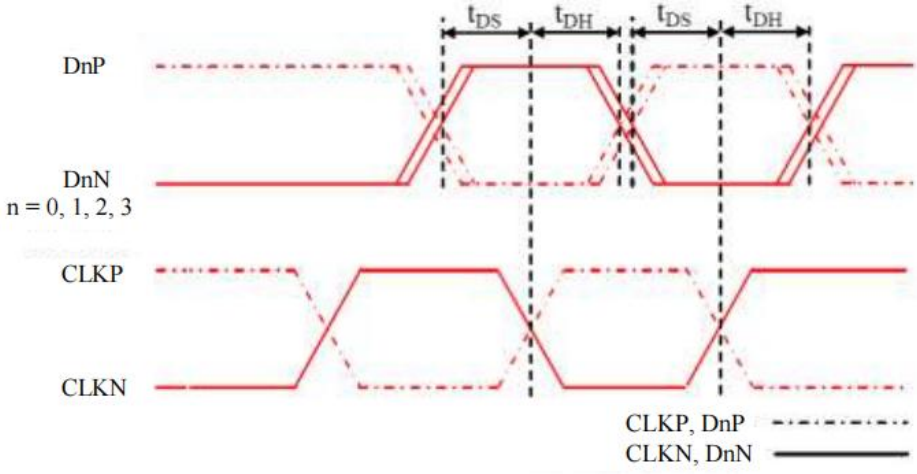


Figure 106: DSI Data to Clock Channel Timings

Table 40: DSI Data to Clock Channel Timings

Signal	Symbol	Parameter	Min	Max
DnP/N , n=0 and 1	t_{DS}	Data to Clock Setup time	0.15xUI	-
	t_{DH}	Clock to Data Hold Time	0.15xUI	-

17.4.4. High Speed Mode – Rising and Falling Timings

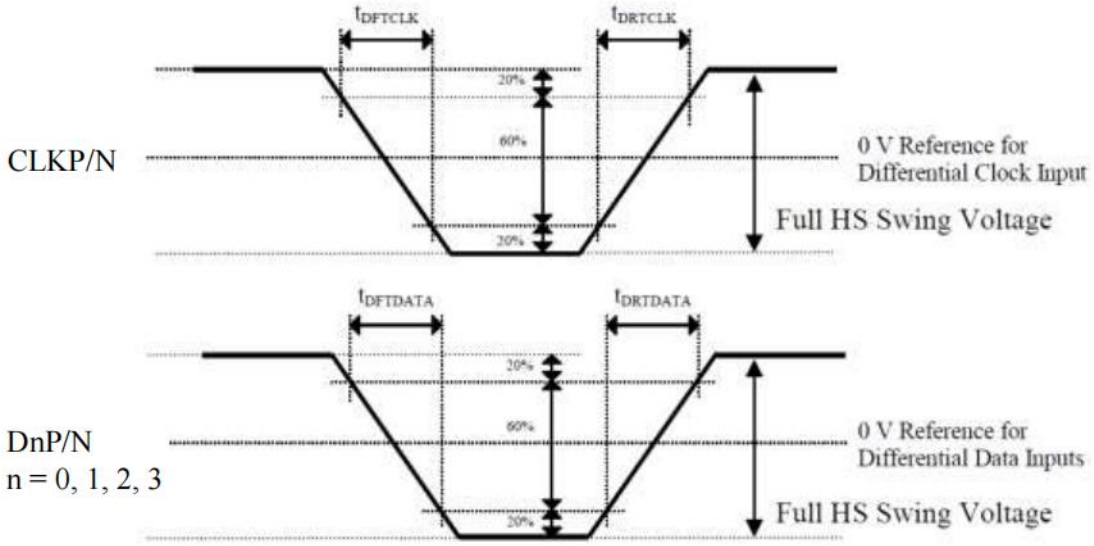


Figure 107: Rising and Falling Timings on Clock and Data Channels

Table 41: Rise and Fall Timings on Clock and Data Channels

Parameter	Symbol	Condition	Specification		
			Min	Typ	Max
Differential Rise Time for Clock	t_{DRTCLK}	CLKP/N	150 ps	-	0.3UI (Note)
Differential Rise Time for Data	$t_{DRTDATA}$	DnP/N n=0 and 1	150 ps	-	0.3UI (Note)
Differential Fall Time for Clock	t_{DFTCLK}	CLKP/N	150 ps	-	0.3UI (Note)
Differential Fall Time for Data	$t_{DFTDATA}$	DnP/N n=0 and 1	150 ps	-	0.3UI (Note)

Note: *The display module has to meet timing requirements, which are defined for the transmitter (MCU) on MIPI D-Phy standard.*

17.4.5. Low Speed Mode – Bus Turn Around

Lower Power Mode and its State Periods on the Bus Turnaround (BTA) from the MCU to the Display Module (ILI9881C-04) are illustrated for reference purposes below.

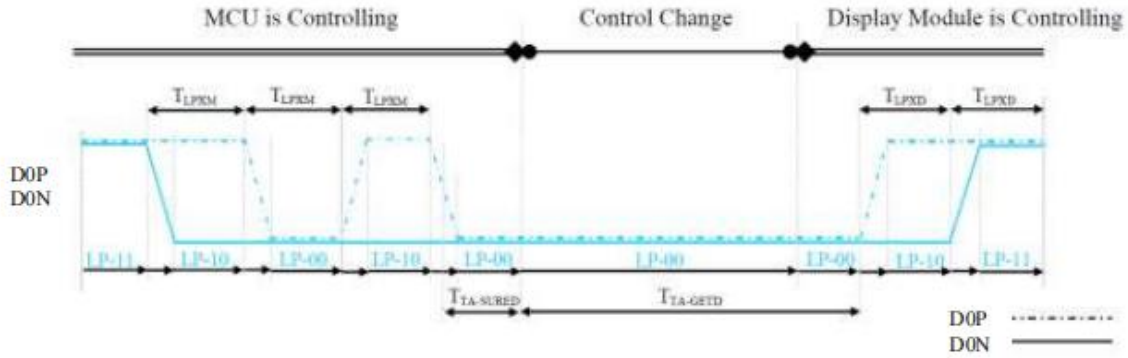


Figure 108: BTA from the MCU to the Display Module

Lower Power Mode and its State Periods on the Bus Turnaround (BTA) from the Display Module (ILI9881C-04) to the MCU are illustrated for reference purposes below.

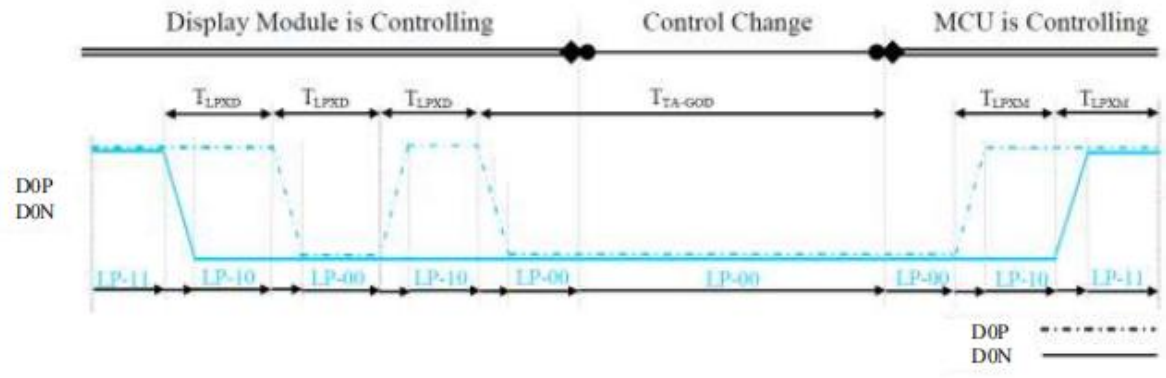


Figure 109: BTA from the Display Module to the MCU

Table 42: Low Power State Period Timings – A

Signal	Symbol	Description	Min	Max	Unit
D0P/N	T_{LPXM}	Length of LP-00, LP-01, LP-10 or LP-11 periods MCU ➔ Display Module (ILI9881C-04)	50	75	ns
D0P/N	T_{LPXD}	Length of LP-00, LP-01, LP-10 or LP-11 periods Display Module (ILI9881C-04) ➔ MCU	50	75	ns
D0P/N	$T_{TA-SURED}$	Time-out before the Display Module (ILI9881C-04) starts driving	T_{LPXD}	$2xT_{LPXD}$	ns

Table 43: Low Power State Period Timings – B

Signal	Symbol	Description	Time	Unit
D0P/N	$T_{TA-GETD}$	Time to drive LP-00 by Display Module (ILI9881C-04)	$5xT_{LPXD}$	ns
D0P/N	T_{TA-GOD}	Time to drive LP-00 after turnaround request - MCU	$4xT_{LPXD}$	ns

17.4.6. Data Lanes from Low Power Mode to High Speed Mode

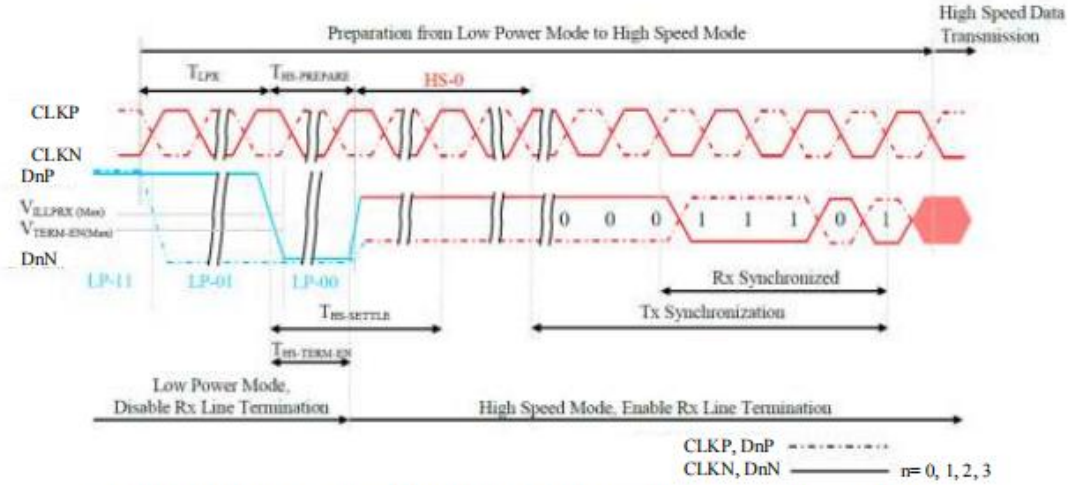


Figure 110: Data Lanes - Low Power Mode to High Speed Mode Timings

Table 44: Data Lanes - Low Power Mode to High Speed Mode Timings

Signal	Symbol	Description	Min	Max	Unit
DnP/N, n = 0 and 1	T_{LPX}	Length of any Low Power State Period	50	-	ns
DnP/N, n = 0 and 1	$T_{HS-PREPARE}$	Time to drive LP-00 to prepare for HS Transmission	40+4xUI	85+6xUI	ns
DnP/N, n = 0 and 1	$T_{HS-TERM-EN}$	Time to enable Data Lane Receiver line termination measured from when Dn crosses VILMAX	-	35+4xUI	ns

17.4.7. Data Lanes from High Speed Mode to Low Power Mode

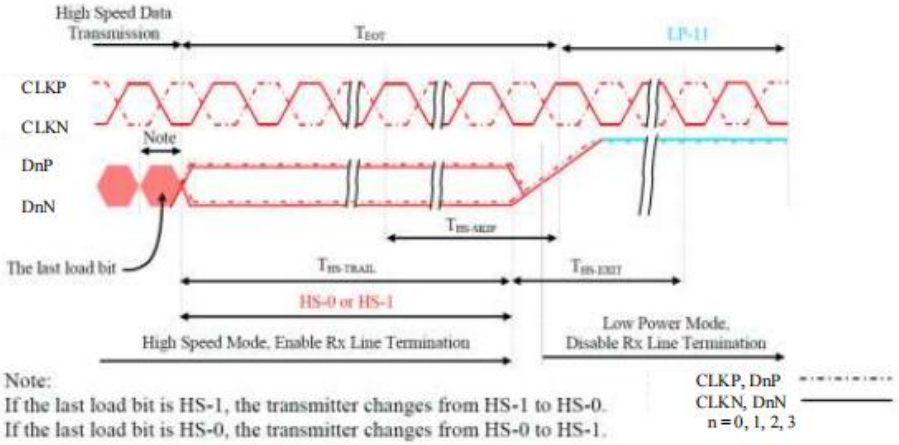


Figure 111: Data Lanes - High Speed Mode to Low Power Mode Timings

Table 45: Data Lanes - High Speed Mode to Low Power Mode Timings

Signal	Symbol	Description	Min	Max	Unit
DnP/N, n = 0 and 1	$T_{HS-SKIP}$	Time-Out at Display Module (ILI9881C-04) to ignore transition period of EoT	40	55+4xUI	ns
DnP/N, n = 0 and 1	$T_{HS-EXIT}$	Time to driver LP-11 after HS burst	100	-	ns

17.4.8. DSI Clock Burst – High Speed Mode to/from Low Power Mode

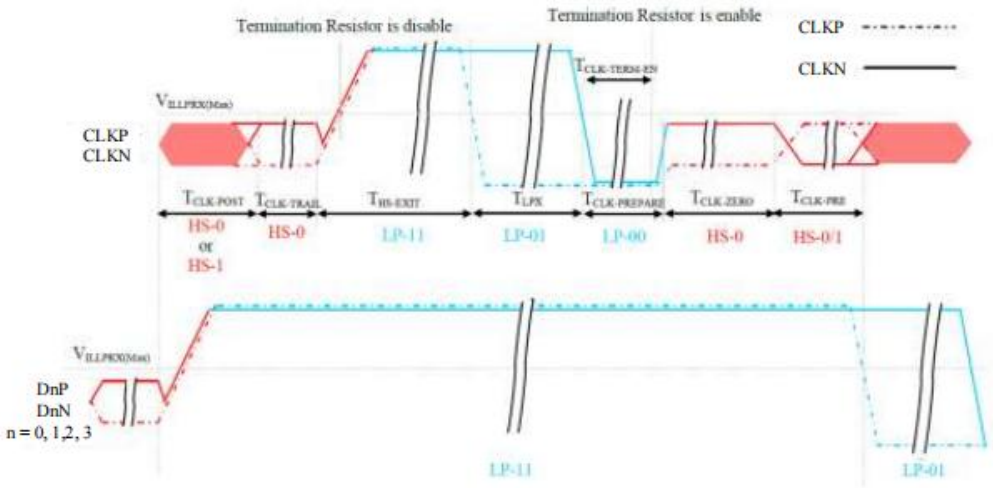
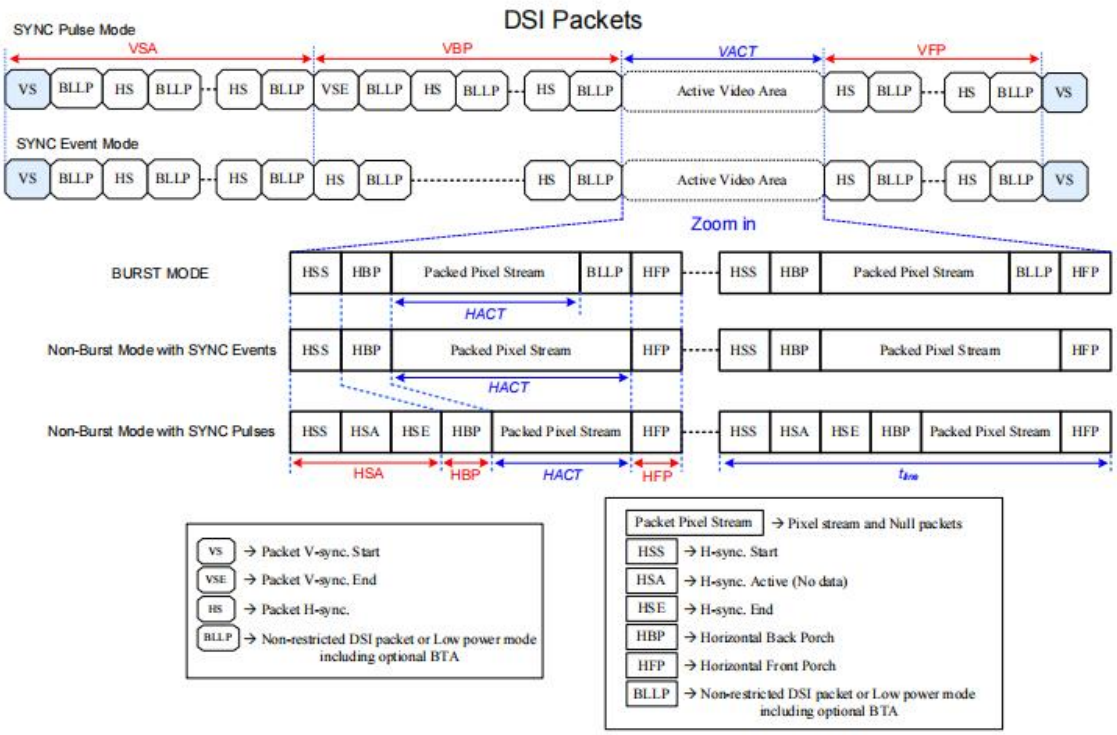


Figure 112: Clock Lanes - High Speed Mode to/from Low Power Mode Timings

Table 46: Clock Lanes - High Speed Mode to/from Low Power Mode Timings

Signal	Symbol	Description	Min	Max	Unit
CLKP/N	$T_{CLK-POST}$	Time that the MCU shall continue sending HS clock after the last associated Data Lanes has transitioned to LP mode	60+52xUI	-	ns
CLKP/N	$T_{CLK-TRAIL}$	Time to drive HS differential state after last payload clock bit of a HS transmission burst	60	-	ns
CLKP/N	$T_{HS-EXIT}$	Time to drive LP-11 after HS burst	100	-	ns
CLKP/N	$T_{CLK-PREPARE}$	Time to drive LP-00 to prepare for HS transmission	38	95	ns
CLKP/N	$T_{CLK-TERM-EN}$	Time-out at Clock Lane to enable HS termination	-	38	ns
CLKP/N	$T_{CLK-PREPARE}$ + $T_{CLK-ZERO}$	Minimum lead HS-0 drive period before starting Clock	300	-	ns
CLKP/N	$T_{CLK-PRE}$	Time that the HS clock shall be driven prior to any associated Data Lane beginning the transition from LP to HS mode	8xUI	-	ns

17.4.9. Timing for DSI video mode



Parameters	Symbols	Min.	Typ.	Max.	Units
Vertical sync. active	VSA	2 (Note 6)	-	-	Line
Vertical Back Porch	VBP	14 (Note 6)	-	-	Line
Vertical Front Porch	VFP	8 (Note 6)	-	-	Line
Active lines per frame	VACT	-	1280	-	Line
Horizontal sync. active	HSA	2	-	-	Pixel
Horizontal Porch period	HSA + HBP + HFP	1.6	-	-	us
Active pixels per line	HACT	-	720	-	Pixel
Bit rate	BR_{bps}	385		Note 5	Mbps/lane

1 UI=1/Bit rate

HSA(pixel)= (tHSA*lane number) / (UI* pixel format)

HBP(pixel)= (tHBP*lane number) / (UI* pixel format)

HFP(pixel)= (tHFP*lane number) / (UI* pixel format)

$$\text{Frame Rate} = \frac{BR_{bps} \times Lane_{num}}{(VACT+VSA+VBP+VFP) \times (HACT+HSA+HBP+HFP) \times \text{Pixel Format}}$$

Example：BR_{bps} = 457Mbps/lane, 1UI=2.1883ns, Frame rate=60Hz, VACT=1280, VSA=2, VBP=30, VFP=20, HACT=720, HSA=33, HBP=100, HFP=100, $Lane_{num}$=4(lane), Pixel Format=24(bit).

Note:

1. $Lane_{num}$: Date lane of MIPI-DSI.
2. Pixel Format: Please reference to “4.1DSI System Interface”.
3. The formula exists slightly error because of the host-transmission way.
4. The best frame rate setting： 2 data lanes：50~60 Hz / 3 data lanes：50~70 Hz / 4 data lanes：50~70 Hz.
5. Please reference to “Table 39: Limited Clock Channel Speed”.
6. The minimum values of this table mean the limitation of IC without considering the panel GIP. The actual values of VSA, VBP and VFP will be changed by different panel GIP setting.

17.4.10. Reset Timing

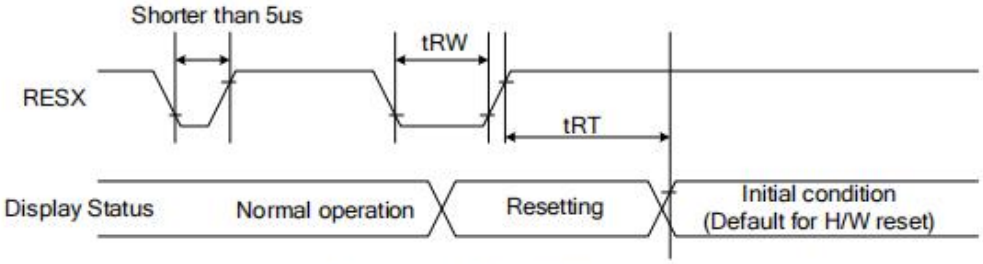


Figure 113: Reset Timing

Table 47: Reset Timing

Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	tRT	Reset cancel		5 (note 1,5)	mS
				120 (note 1,6,7)	mS

Notes:

1. *The reset cancel also includes required time for loading ID bytes, VCOM setting and other settings from EEPROM to registers. This loading is done every time when there is H/W reset cancel time (tRT) within 5 ms after a rising edge of RESX.*
2. *Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the Table 48.*

Table 48: Reset Descript

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

3. During the Resetting period, the display will be blanked (The display enters the blanking sequence, which maximum time is 120 ms, when Reset Starts in the Sleep Out mode. The display remains the blank state in the Sleep In mode.) and then return to Default condition for Hardware Reset.
4. Spike Rejection can also be applied during a valid reset pulse, as shown below:

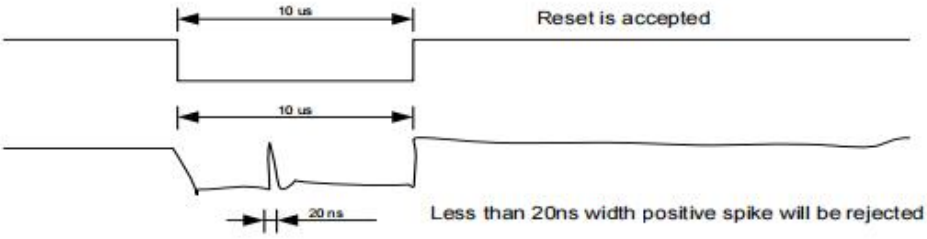


Figure 114: Positive Noise Pulse during Reset Low

5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

8. Electro-Optical Characteristics

Item		Symbol	Condition	Min	Type	Max	Unit	Note
White luminance (Center)		Lv	Θ=0 Normal Viewing Angle I_{BL}=40mA	--	350	--	cd/m²	(4)(5)(7)
Response time		Tr+Tf		--	10	15	ms	(1)(3)
Contrast ratio		CR		640	800	--	--	(1)(2)
Color Chromaticity (CIE1931)	white	Wx		0.283	0.303	0.323		(1)(4)
		Wy		0.303	0.323	0.343		
Viewing Angle	Hor	ΘL	CR≥10	--	80	--		(1) (4) Measuring with Polarizer, Reference Only
		ΘR		--	80	--		
	Ver	ΘU		--	80	--		
		ΘD		--	80	--		
Brightness uniformity		Avg	Θ=0	80	90	--	%	(5)
Color Gamut		NTSC	Θ=0	--	70	--	%	C-light
Optima View Direction		ALL						(5)

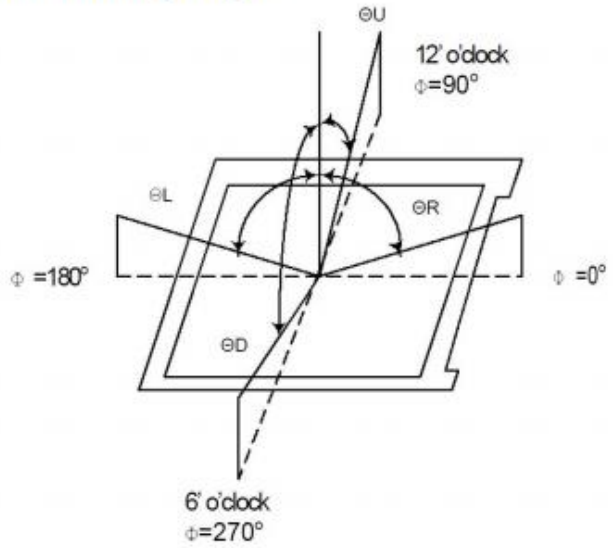
3.2 Measuring Condition

- Measuring surrounding: dark room
- LED current IL:40mA
- Ambient temperature: 25±2℃
- 15min. warm-up time

3.3 Measuring Equipment

- FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-7 for other optical characteristics.
- Measuring spot size： 20 ~ 21 mm

Note (1) Definition of Viewing Angle

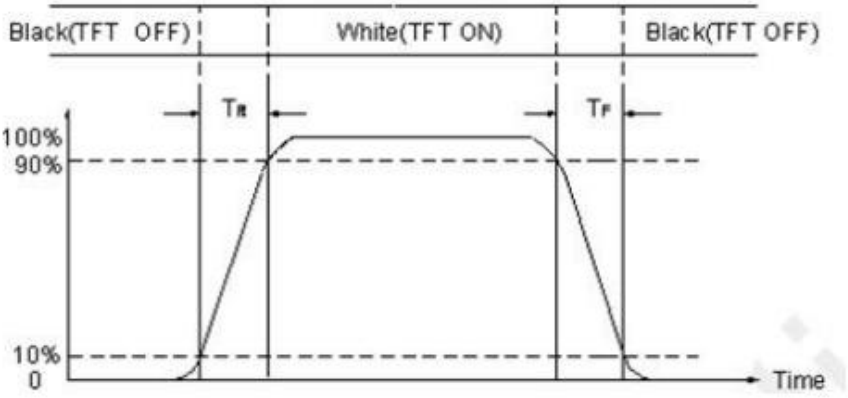


Note (2) Definition of Contrast Ratio(CR):

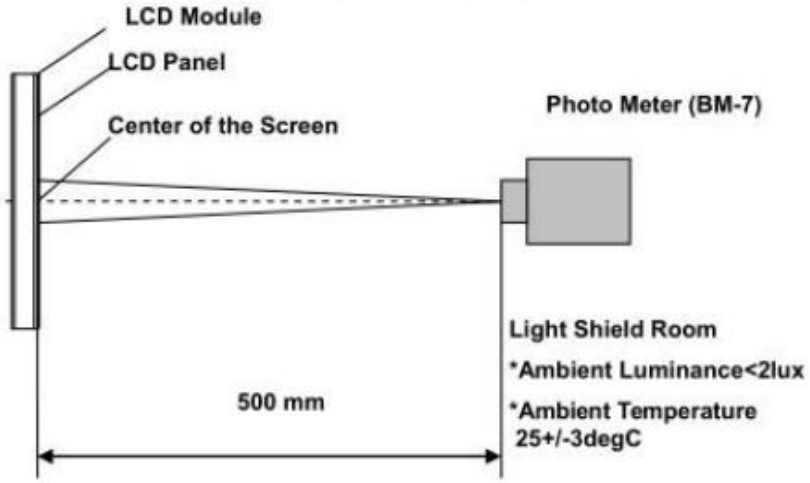
Measured at the center point of panel

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

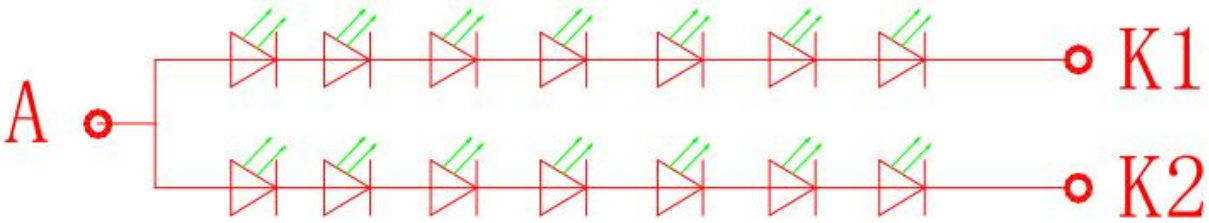
Note (3) Definition of Response Time: Sum of TR and TF



Note (4) Definition of optical measurement setup



Note(4) Backlight circuit



40mA, 19.6V-22.4V

9.Records Of Version

Version	Revise Date	Page	Content
00		ALL	New released